

MiniSKiiP® 3

Converter-Inverter-Brake (CIB)

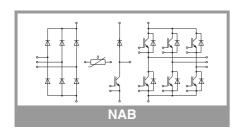
SKiiP 39NAB12T7V1

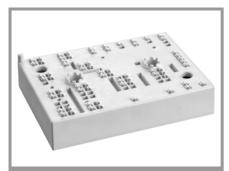
Features*

- 1200V Generation 7 IGBTs (T7)
- Robust and soft switching freewheeling diodes in CAL technology
- New SKR PEP diode technology for enhanced power and environmental robustness
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

- Max. case temperature limited to TC=TS=125 °C
- Product reliability results valid for Tj≤150 °C; Tj,op >150°C during overload (Details see AN19-002)
- MiniSKiiP "Technical Explanations" and "Mounting Instructions" are part of the data sheet. Please refer to both documents for further information.
- For storage and case temperature with TIM see document "Technical Explanations Thermal Interface Materials"
- Inverter IGBT: T1 T6
 Chopper IGBT: T14
 Inverse Diode: D1 D6
- Freewheeling Diode: D13Rectifier Diode: D7 D12
- All graphs are referring to inverter/ rectifier part

Absolut	e Maximum Ratings	s		
Symbol	Conditions		Values	Unit
Inverter	- IGBT			•
V _{CES}	T _j = 25 °C		1200	V
Ic	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	135	Α
	T _j = 175 °C	T _s = 100 °C	108	Α
I _C	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	169	Α
	T _j = 175 °C	T _s = 100 °C	137	Α
I _{Cnom}			150	Α
I _{CRM}			300	Α
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 15 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 175 °C	7	μs
Tj			-40 175	°C
Chopper	r - IGBT			
V _{CES}	T _j = 25 °C		1200	V
Ic	λ_{paste} =0.8 W/(mK)	T _s = 70 °C	120	Α
	T _j = 175 °C	T _s = 100 °C	98	Α
Ic	λ_{paste} =2.5 W/(mK)	T _s = 70 °C	143	Α
	T _j = 175 °C	T _s = 100 °C	116	Α
I _{Cnom}			100	Α
I _{CRM}			200	Α
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 15 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 175 °C	7	μs
Tj			-40 175	°C
Inverse -	- Diode			
V_{RRM}	T _j = 25 °C		1200	V
l _F	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	88	Α
	T _j = 175 °C	T _s = 100 °C	69	Α
l _F	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	106	Α
	T _j = 175 °C	T _s = 100 °C	85	Α
I _{FRM}			300	Α
I_{FSM}	$t_p = 10 \text{ ms, sin } 180^\circ$	°, T _j = 150 °C	760	Α
T_j			-40 175	°C
Freewhe	eling - Diode			
V_{RRM}	$T_j = 25 ^{\circ}\text{C}$		1200	V
l _F	λ_{paste} =0.8 W/(mK)	T _s = 70 °C	80	Α
	T _j = 175 °C	T _s = 100 °C	64	Α
l _F	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	94	Α
	T _j = 175 °C	T _s = 100 °C	75	Α
I _{FRM}			200	Α
I _{FSM}	$t_p = 10 \text{ ms}, \sin 180^\circ$	°, T _j = 150 °C	550	Α
T_j			-40 175	°C





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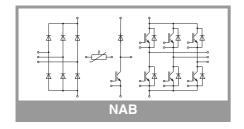
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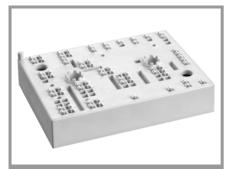
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Absolute Maximum Ratings								
Symbol	Conditions		Values	Unit				
Rectifier -	- Diode							
V_{RRM}	T _j = 25 °C		1600	V				
l _F	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	144	А				
	T _j = 175 °C	T _s = 100 °C	112	Α				
l _F	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	159	А				
	T _j = 175 °C	T _s = 100 °C	125	А				
I _{FSM}	t _p = 10 ms	T _j = 25 °C	1000	А				
	sin 180°	T _j = 150 °C	890	Α				
i ² t	t _p = 10 ms	T _j = 25 °C	5000	A ² s				
	sin 180°	T _j = 150 °C	3960	A ² s				
Tj			-40 175	°C				
Module								
I _{t(RMS)}	T _{terminal} = 80 °C, 20	A per spring	80	Α				
T _{stg}	module without TIN	Л	-40 125	°C				
V _{isol}	AC sinus 50 Hz, 1	min	2500	V				

Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverter -	IGBT					
V _{CE(sat)}	I _C = 150 A	T _j = 25 °C		1.55	1.70	V
	$V_{GE} = 15 \text{ V}$	T _j = 150 °C		1.73	1.88	V
	chiplevel	T _j = 175 °C		1.77	1.92	V
V_{CE0}		T _j = 25 °C		1.00	1.05	V
	chiplevel	T _j = 150 °C		0.80	0.85	V
		T _j = 175 °C		0.75	0.80	V
r _{CE}	V 45.V	T _j = 25 °C		3.7	4.3	mΩ
	V _{GE} = 15 V chiplevel	T _j = 150 °C		6.2	6.9	mΩ
	ompievei	T _j = 175 °C		6.8	7.5	mΩ
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_{C} = 3.5$	5.15	5.8	6.45	V	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	00 V, T _j = 25 °C			1.5	mA
C _{ies}	V 05.V	f = 1 MHz		30.00		nF
Coes	$V_{CE} = 25 \text{ V}$ $V_{GE} = 0 \text{ V}$	f = 1 MHz		0.39		nF
C _{res}	VGE - V	f = 1 MHz		0.10		nF
Q_G	V _{GE} = - 8V + 15 \	ĺ		2100		nC
R _{Gint}	T _j = 25 °C			1.0		Ω
t _{d(on)}	$V_{CC} = 600 \text{ V}$	T _j = 25 °C		170		ns
	I _C = 150 A	T _j = 150 °C	C 183 C 34			ns
	$R_{G \text{ on}} = 1.1 \Omega$ $R_{G \text{ off}} = 1.1 \Omega$	T _j = 175 °C				ns
t _r	$V_{GE} = +15/-15 \text{ V}$	T _j = 25 °C				ns
	GL	T _j = 150 °C				ns
	O.T. 450.00:	T _j = 175 °C		40		ns
E _{on}	@ T _j = 150 °C: di/dt _{on} = 3970 A/μs	T _j = 25 °C		4.6		mJ
	$di/dt_{off} = 1530 \text{ A/}\mu\text{s}$	T _j = 150 °C		9.9		mJ
_	dv/dt = 3730 V/μs	T _j = 175 °C		12		mJ





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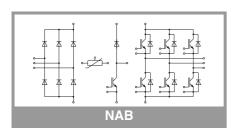
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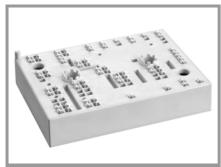
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Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverter -				,,		ı
t _{d(off)}	V _{CC} = 600 V	T _i = 25 °C		274		ns
-u(oii)	I _C = 150 A	T _i = 150 °C		370		ns
	$R_{G \text{ on}} = 1.1 \Omega$	T _i = 175 °C		389		ns
t _f	$R_{G \text{ off}} = 1.1 \Omega$	T _i = 25 °C	65			ns
4	$V_{GE} = +15/-15 \text{ V}$	T _i = 150 °C		100		ns
		T _i = 175 °C		106		ns
E _{off}	@ T _j = 150 °C:	T _i = 25 °C		11		mJ
-011	$di/dt_{on} = 3970 \text{ A/}\mu\text{s}$ $di/dt_{off} = 1530 \text{ A/}\mu\text{s}$	•		18.7		mJ
	dv/dt = 3730 V/μs	T _i = 175 °C		21		mJ
R _{th(j-s)}	per IGBT, λ_{paste} =0.8	•		0.43		K/W
R _{th(j-s)}	per IGBT, λ_{paste} =2.5			0.3		K/W
Chopper				0.0		1,4,44
V _{CE(sat)}	1	T _j = 25 °C		1.50	1.70	V
V CE(sat)	I _C = 100 A V _{GE} = 15 V	T _i = 150 °C		1.68	1.88	V
	chiplevel	T _i = 175 °C		1.77	1.92	V
V _{CE0}		T _i = 25 °C		1.00	1.05	V
V CE0	chiplevel	T _i = 150 °C		0.80	0.85	V
	Chipievei	T _i = 175 °C		0.75	0.80	V
r		T _i = 25 °C		5.0	6.5	mΩ
r _{CE}	V _{GE} = 15 V	T _i = 150 °C				1
	chiplevel	T _i = 175 °C		8.8	10	mΩ
W	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		5.15	10	6.45	mΩ V
V _{GE(th)}	$V_{GE} = V_{CE}, I_C = 2.5$		5.15	5.8		1
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	f = 1 MHz		01.70	1	mA
Cies	V _{CE} = 25 V	f = 1 MHz		21.70		nF nF
Coes	$V_{GE} = 0 V$			0.28		-
C _{res}	V _{GE} = - 8V + 15 V	f = 1 MHz		nF		
Q _G	The state of the s	'		1400		nC
R _{Gint}	T _j = 25 °C	T 05 °C		1.5		Ω
t _{d(on)}	_	T _j = 25 °C		162 171		ns
	_	T _j = 150 °C		ns		
	_	T _j = 175 °C		173		ns
t _r	_	T _j = 25 °C 31				ns ns
	V _{CC} = 600 V	T _j = 150 °C				
_	$I_{\rm C} = 100 {\rm A}$	T _j = 175 °C	38			ns mJ
E _{on}	$R_{G \text{ on}} = 1.7 \Omega$ $R_{G \text{ off}} = 1.7 \Omega$	T _j = 25 °C		5		
	$V_{GE} = +15/-15 \text{ V}$	T _j = 150 °C		9.3		mJ
1	-	T _j = 175 °C		11		mJ
t _{d(off)}		T _j = 25 °C		256		ns
	@ T _j = 150 °C:	T _j = 150 °C		350		ns
	$di/dt_{on} = 2620 \text{ A/}\mu\text{s}$ $di/dt_{off} = 1030 \text{ A/}\mu\text{s}$ $dv/dt = 3680 \text{ V/}\mu\text{s}$	1 _j = 1/5 'C		368		ns
t _f	$dv/dt = 3680 V/\mu s$			57		ns
	-	T _j = 150 °C	89			ns
_	_	T _j = 175 °C		100		ns
E _{off}	_	T _j = 25 °C		6.6		mJ mJ
	_	T _j = 150 °C		12		
	1077	T _j = 175 °C	13 0.41			mJ
R _{th(j-s)}	per IGBT, λ _{paste} =0.8			K/W		
$R_{th(j-s)}$	per IGBT, λ_{paste} =2.5	vv/(mK)		K/W		



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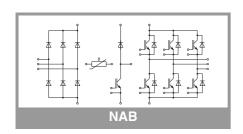
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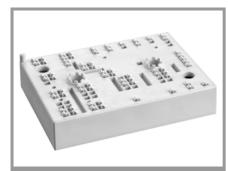
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Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse -	Diode					
$V_F = V_{EC}$	I _F = 150 A	T _j = 25 °C		2.28	2.63	٧
	$V_{GE} = 0 V$	T _j = 150 °C		2.28	2.61	٧
	chiplevel	T _j = 175 °C		2.12	2.46	٧
V _{F0}		T _j = 25 °C		1.30	1.50	٧
	chiplevel	T _j = 150 °C		0.90	1.10	٧
		T _j = 175 °C		0.82	0.98	V
r _F		T _j = 25 °C		6.6	7.5	mΩ
	chiplevel	T _j = 150 °C		9.2	10	mΩ
		T _j = 175 °C		8.6	9.8	mΩ
I _{RRM}		T _j = 25 °C		193		Α
		T _j = 150 °C		241		Α
	V _{CC} = 600 V	T _j = 175 °C		255		Α
Q _{rr}	I _F = 150 A	T _i = 25 °C		9		μC
	$V_{GE} = -15 \text{ V}$	T _i = 150 °C		23		μС
	@ T _j = 150 °C:	T _j = 175 °C		28		μC
E _{rr}	$di/dt_{off} = 3910 \text{ A/}\mu\text{s}$	T _i = 25 °C		4.8		mJ
		T _i = 150 °C		12		mJ
	_	T _i = 175 °C		14		mJ
R _{th(j-s)}	per Diode, λ _{paste} =0.	8 W/(mK)		0.65		K/W
R _{th(j-s)}	per Diode, λ _{paste} =2.			0.49		K/W
Freewhee	eling - Diode					ı
$V_F = V_{EC}$	I _F = 100 A	T _i = 25 °C		2.20	2.52	V
	$V_{GE} = 0 V$	T _j = 150 °C		2.15	2.47	V
	chiplevel	T _j = 175 °C		2.00	2.31	V
V _{F0}		T _j = 25 °C		1.30	1.50	V
	chiplevel	T _j = 150 °C		0.90	1.10	V
		T _j = 175 °C		0.82	0.98	V
r _F		T _j = 25 °C		9.0	10	mΩ
	chiplevel	T _j = 150 °C		13	14	mΩ
		T _j = 175 °C		12	13	mΩ
I _{RRM}		T _j = 25 °C		93		Α
		T _j = 150 °C		116		Α
	V _{CC} = 600 V	T _j = 175 °C		120		Α
Q _{rr}	I _F = 100 A	T _j = 25 °C		5.9		μC
	$V_{GE} = -15 \text{ V}$	T _j = 150 °C		15		μС
	@ T _i = 150 °C:	T _j = 175 °C		19		μC
E _{rr}	$di/dt_{off} = 2590 \text{ A/}\mu\text{s}$	*		2.2		mJ
		T _j = 150 °C		5.9		mJ
		T _j = 175 °C		7.3		mJ
R _{th(j-s)}	per Diode, λ _{paste} =0.	8 W/(mK)		0.65		K/W
R _{th(j-s)}	per Diode, λ _{paste} =2.			0.51		K/W





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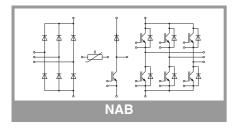
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Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
Rectifier	- Diode					
V_{F}	1 44 4	T _j = 25 °C		0.97	1.20	V
	I _F = 44 A chiplevel	T _j = 150 °C		0.84	1.07	V
	o inplovo	T _j = 175 °C		0.82	1.05	V
V_{F0}		T _j = 25 °C		0.89	1.09	V
	chiplevel	T _j = 150 °C		0.73	0.92	V
		T _j = 175 °C		0.69	0.88	V
r _F		T _j = 25 °C		1.84	2.5	mΩ
	chiplevel	T _j = 150 °C		2.6	3.5	mΩ
		T _j = 175 °C		2.9	3.9	mΩ
I _R	T _j = 150 °C, V _F	RRM			1.7	mA
R _{th(j-s)}	per Diode, λ _{pas}		0.51		K/W	
R _{th(j-s)}	per Diode, λ _{pas}		0.44		K/W	
Module						
Ms	to heat sink		2		2.5	Nm
W				82		g
L _{CE}				-		nΗ
Tempera	ture Sensor					
R ₁₀₀	T _r =100°C (R ₂₅	=1000Ω)		1670 ± 3%		Ω
R _(T)	$R_{(T)}$ =1000 Ω [1- , A = 7.635*10 B = 1.731*10 ⁻⁵					

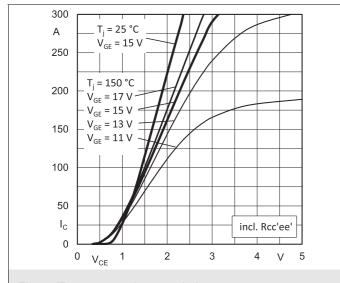


Fig. 1: Typ. output characteristic

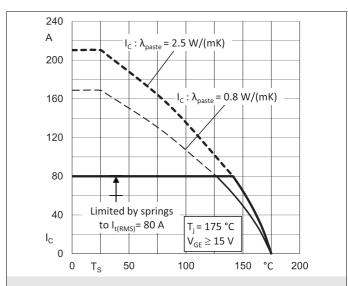


Fig. 2: Typ. rated current vs. temperature Ic = f(Ts)

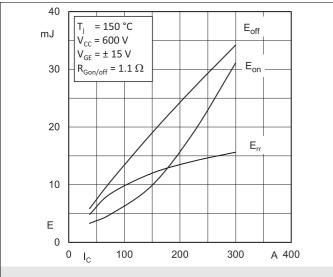


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

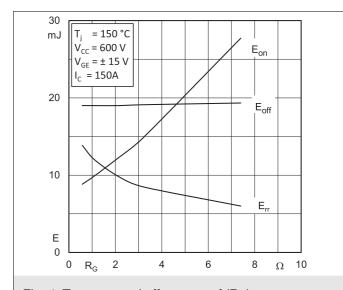


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

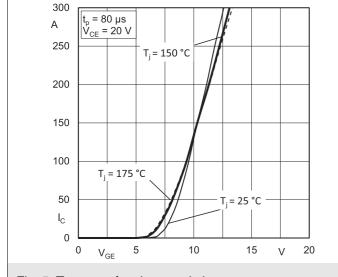


Fig. 5: Typ. transfer characteristic

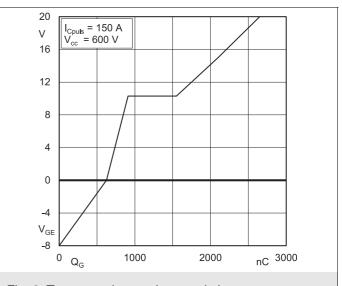
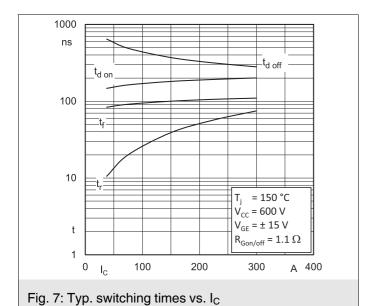


Fig. 6: Typ. gate charge characteristic



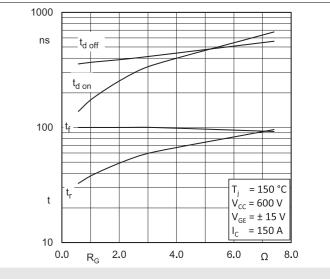


Fig. 8: Typ. switching times vs. gate resistor R_{G}

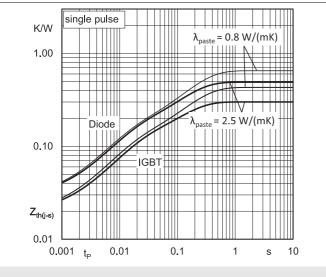


Fig. 9: Typ. transient thermal impedance

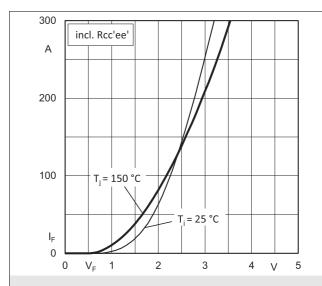


Fig. 10: Typ. CAL diode forward characteristic

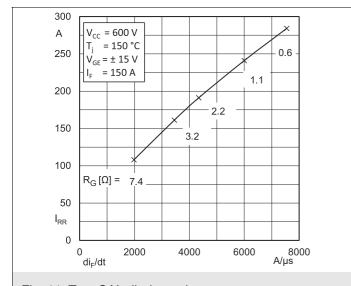


Fig. 11: Typ. CAL diode peak reverse recovery current

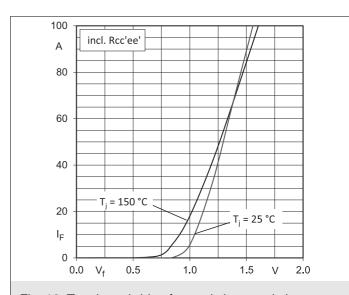
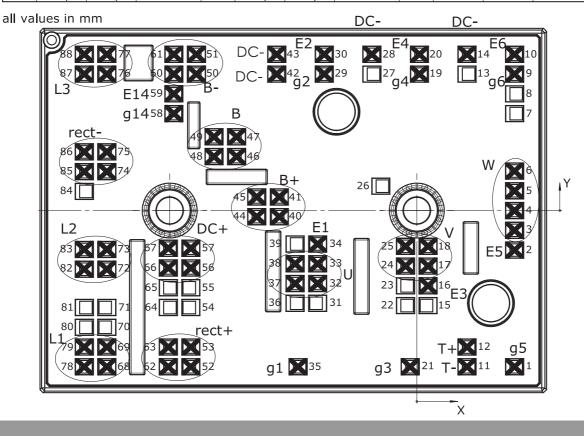


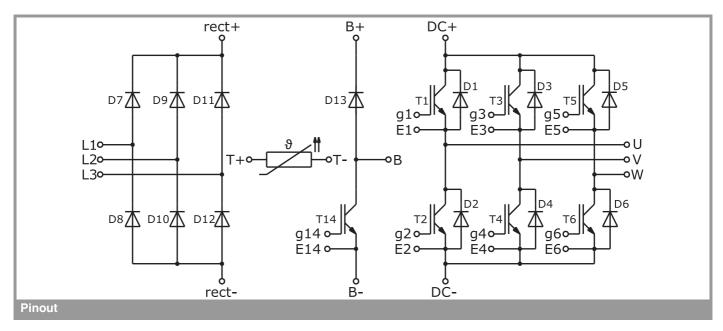
Fig. 12: Typ. input bridge forward characteristic

Pin out											
Pin	X	Υ	Function	Pin	X	Υ	Function	Pin	X	Υ	Function
1	15,83	-25,30	g5	31	-16,05	-15,02		61	-39,33	25,30	B-
2	15,83	-6,40	E5	32	-16,05	-11,82	U	62	-40,23	- 25,30	rect+
3	15,83	- 3,20	W	33	-16,05	- 8,62	U	63	-40,23		
4	15,83	0	W	34	-16,05		E1	64	-40,23	-15,70	
5	15,83	3,20	W	35	-19,23	-25,30	g1	65	-40,23	-12,50	
6	15,83	6,40	W	36	-19,70	-15,02		66	-40,23	- 9,30	DC+
7	15,83	15,70		37	-19,70	-11,82	U	67	-40,23	-6,10	DC+
8	15,83	18,90		38	-19,70		U	68	-50,18	- 25,30	L1
9	15,83	22,10	g6	39	-19,70	-5,42		69	-50,18	-22,10	L1
10	15,83	25,30	E6	40	- 22,26	-1,00	B+	70	-50,18	-18,90	
11	8,13	- 25,30	T-	41	-22,26	2,20	B+	71	-50,18	-15,70	
12	8,13	-22,10	T+	42	-22,68		DC-	72	-50,18		L2
13	8,13	22,10		43	-22,68	25,30	DC-	73	-50,18	-6,30	L2
14	8,13	25,30	DC-	44	-25,91	-1,00	B+	74	-50,18	6,30	rect-
15	1,83	-15,39		45	-25,91	2,20	B+	75	-50,18	9,50	rect-
16	1,83	-12,19	E3	46	-29,18	8,74	В	76	-50,18	22,10	L3
17	1,83	- 8,99	V	47	-29,18		В	77	-50,18	25,30	L3
18	1,83	- 5,79	V	48	-32,83		В	78	-53,83		
19	0,43	22,10	g4	49	-32,83		В	79	-53,83	-22,10	L1
20	0,43	25,30	E4	50	-35,68		B-	80	-53,83	-18,90	
21	-1,08	- 25,30	g3	51	- 35,68			81	- 53,83	- 15,70	
22	-1,83	-15,39		52	-36,58			82	-53,83	-9,50	L2
23	-1,83	-12,19		53	-36,58		rect+	83	-53,83	-6,30	L2
24	-1,83	- 8,99	V	54	-36,58			84	-53,83	3,10	
25	-1,83		V	55	-36,58			85	-53,83	6,30	rect-
26	-5,83	3,95		56	-36,58		DC+	86	-53,83	9,50	rect-
27	-7,28	22,10		57	-36,58		DC+	87	-53,83	22,10	L3
28	- 7,28		DC-	58	-39,33		g14	88	- 53,83	25,30	L3
29	-14,98		g2	59	-39,33		E14				
30	-14,98	25,30	E2	60	-39,33	22,10	B-				



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Pinout



This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

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